



SBR3A40SA

3.0A SBR® SUPER BARRIER RECTIFIER SMA

Features

- Low Leakage Current
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- Lead Free Finish, RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- SBR3A40SAQ Qualified to AEC-Q101 standards for High Reliability.

Mechanical Data

- Case: SMA
- Case Material: Molded Plastic, "Green" Molding compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Lead Free Plating (Matte Tin Finish.) Solderable per MIL-STD-202, Method 208 @3
- Polarity Indicator: Cathode Band
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.064 grams (approximate)







Bottom View

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
SBR3A40SA-13	Commercial	SMA	5000/Tape & Reel
SBR3A40SAQ-13	Automotive	SMA	5000/Tape & Reel

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied. 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

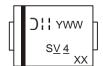
Notes:

and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

5. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.

Marking Information



SV 4 = Product Type Marking Code) = Manufacturers' code marking YWW = Date Code Marking Y = Last digit of year (ex: 7 for 2007) WW = Week code 01 to 52

Notes: 6. Device has a cathode band (as shown above) and may also have a cathode notch.



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	40	V
Maximum Voltage Rate of Change (Rated V _R)	dv/dt	10,000	V/µs
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Rectified Output Current	lo	3	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	IFSM	45	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Thermal Resistance Junction to Soldering (Note 7) Thermal Resistance Junction to Ambient (Note 8) Thermal Resistance Junction to Case (Note 8)	$egin{array}{c} R_{ extsf{ heta}JA} \ R_{ extsf{ heta}JC} \ R_{ extsf{ heta}JC} \end{array}$	5 124 14.3	°C/W
Power Dissipation (Note 8) $@T_A = +25^{\circ}C$	PD	1.2	W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

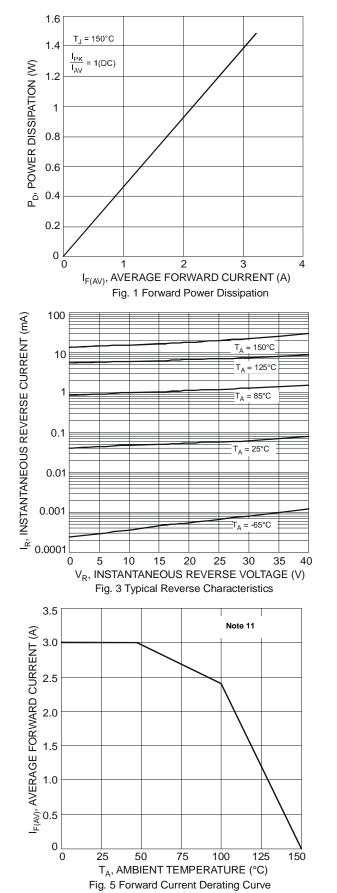
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 10)	V _{(BR)R}	40	-	-	V	$I_R = 0.4 \text{mA}$
Forward Voltage Drop	VF	_ _ _	0.30 0.33 0.43 -	0.35 0.38 0.50 0.48	V	$\begin{split} I_F &= 0.5A, \ T_J = +25^{\circ}C \\ I_F &= 1.0A, \ T_J = +25^{\circ}C \\ I_F &= 3.0A, \ T_J = +25^{\circ}C \\ I_F &= 3.0A, \ T_J = +125^{\circ}C \end{split}$
Leakage Current (Note 10)	I _R	_	45 80 9	250 400 40	μA μA mA	$V_R = 5V$, $T_J = +25^{\circ}C$ $V_R = 40V$, $T_J = +25^{\circ}C$ $V_R = 40V$, $T_J = +125^{\circ}C$

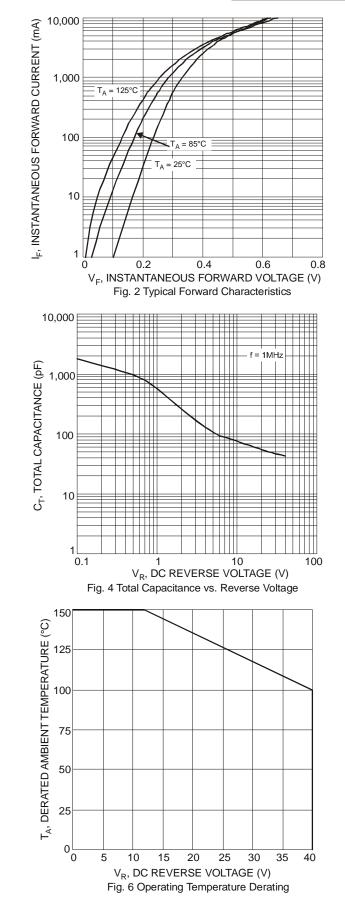
Notes:

7. Theoretical R_{0JS} calculated from the top center of the die straight down to the PCB cathode tab solder junction.
8. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.
9. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.
10. Short duration pulse test used to minimize self-heating effect.
11. FR-4 PCB, 2 oz. Copper, single side 16 x MRP, 1" x 1" PC Board.









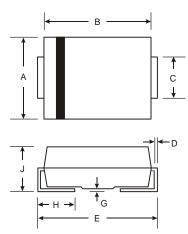
SBR is a registered trademark of Diodes Incorporated. SBR3A40SA Document number: DS31107 Rev. 11 - 2

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Package Outline Dimensions

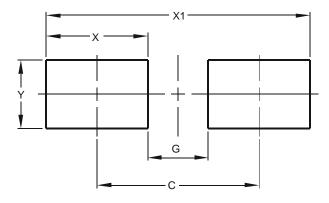
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SMA			
Dim	Min	Max	
Α	2.29	2.92	
В	4.00	4.60	
С	1.27	1.63	
D	0.15	0.31	
Е	4.80	5.59	
G	0.05	0.20	
н	0.76	1.52	
J	2.01	2.30	
All Dim	All Dimensions in mm		

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	4.00
G	1.50
Х	2.50
X1	6.50
Y	1.70



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